

OVERVIEW

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Radial Leaded PTC Resettable Fuse: FRX Series

1. Summary

(a) RoHS Compliant (Lead Free) Product

(b) Applications : Wide variety of electronic equipment

(c) Product Features : Low hold current, Solid state, Radial leaded product ideal for up to 60V

(d) Operation Current: 50mA~3.75A

(e) Maximum Voltage: 60V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: File No. E211981 C-UL: File No. E211981 TÜV: File No. R 50004084

3. Electrical Characteristics (23°C)

Part	Hold	Trip		Maximum	Rated	Typical		stance rance
Number	Current	Current	to Trip	Current	Voltage	Power	RMIN	R1max
	Ін,А	Іт,А	at 5хIн	IMAX,A	V _{MAX} ,V _{DC}	Pd, W	ohms	ohms
FRX005- 60F	0.05	0.10	5.0	40	60	0.26	7.30	20.0
FRX010- 60F	0.10	0.20	4.0	40	60	0.38	2.50	7.50
FRX017- 60F	0.17	0.34	3.0	40	60	0.48	2.00	8.00
FRX020- 60F	0.20	0.40	2.2	40	60	0.41	1.83	4.40
FRX025- 60F	0.25	0.50	2.5	40	60	0.45	1.25	3.00
FRX030- 60F	0.30	0.60	3.0	40	60	0.49	0.88	2.10
FRX040- 60F	0.40	0.80	3.8	40	60	0.56	0.55	1.29
FRX050- 60F	0.50	1.00	4.0	40	60	0.77	0.50	1.17
FRX065- 60F	0.65	1.30	5.3	40	60	0.88	0.31	0.72
FRX075- 60F	0.75	1.50	6.3	40	60	0.92	0.25	0.60
FRX090- 60F	0.90	1.80	7.2	40	60	0.99	0.20	0.47
FRX110- 60F	1.10	2.20	8.2	40	60	1.50	0.15	0.38
FRX135- 60F	1.35	2.70	9.6	40	60	1.70	0.12	0.30
FRX160- 60F	1.60	3.20	11.4	40	60	1.90	0.09	0.22
FRX185- 60F	1.85	3.70	12.6	40	60	2.10	0.08	0.19
FRX250- 60F	2.50	5.00	15.6	40	60	2.50	0.05	0.13
FRX300- 60F	3.00	6.00	19.8	40	60	2.80	0.04	0.10
FRX375- 60F	3.75	7.50	24.0	40	60	3.20	0.03	0.08

H=Hold current-maximum current at which the device will not trip at 23°℃ still air.

I₁=Trip current-minimum current at which the device will always trip at 23°ℂ still air.

V MAX=Maximum voltage device can withstand without damage at its rated current.

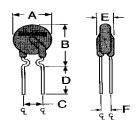
I MAX= Maximum fault current device can withstand without damage at rated voltage (V MAX).

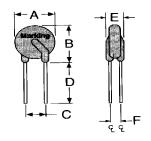
Pd=Typical power dissipated from device when in tripped state in 23°ℂ still air environment.

RMIN=Minimum device resistance at 23°ℂ, 1 hour after tripping.



4. Production Dimensions (millimeter)

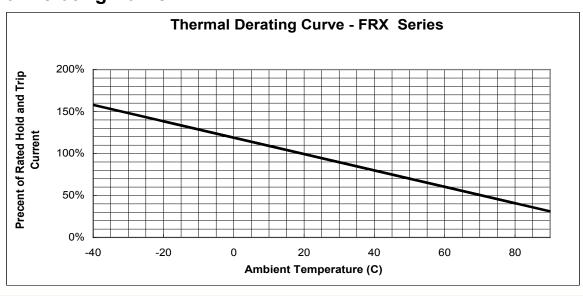




FRX 005-60F ~ FRX 090-60F Lead Size : 24AWG Φ 0.51 mm Diameter

FRX 110-60F ~ FRX 375-60F Lead Size : 20AWG Φ 0.81 mm Diameter

	Ψ 0.5	1 mm Diameter	Ψ 0.8	31 mm Diameter		
Part	Α	В	С	D	E	F
Number	Maximum	Maximum	Typical	Minimum	Maximum	Typical
FRX005-60F	7.4	12.7	5.1	7.6	3.1	1.1
FRX010-60F	7.4	12.7	5.1	7.6	3.1	1.1
FRX017-60F	7.4	12.7	5.1	7.6	3.1	1.1
FRX020-60F	7.4	12.7	5.1	7.6	3.1	1.1
FRX025-60F	7.4	12.7	5.1	7.6	3.1	1.1
FRX030-60F	7.4	13.0	5.1	7.6	3.1	1.1
FRX040-60F	7.6	13.5	5.1	7.6	3.1	1.1
FRX050-60F	7.9	13.7	5.1	7.6	3.1	1.1
FRX065-60F	9.7	14.5	5.1	7.6	3.1	1.1
FRX075-60F	10.4	15.2	5.1	7.6	3.1	1.1
FRX090-60F	11.7	15.8	5.1	7.6	3.1	1.1
FRX110-60F	13.0	18.0	5.1	7.6	3.1	1.4
FRX135-60F	14.5	19.6	5.1	7.6	3.1	1.4
FRX160-60F	16.3	21.3	5.1	7.6	3.1	1.4
FRX185-60F	17.8	22.9	5.1	7.6	3.1	1.4
FRX250-60F	21.3	26.4	10.2	7.6	3.1	1.4
FRX300-60F	24.9	30.0	10.2	7.6	3.1	1.4
FPY375-60F	28.5	33.5	10.2	7.6	3 1	1 /

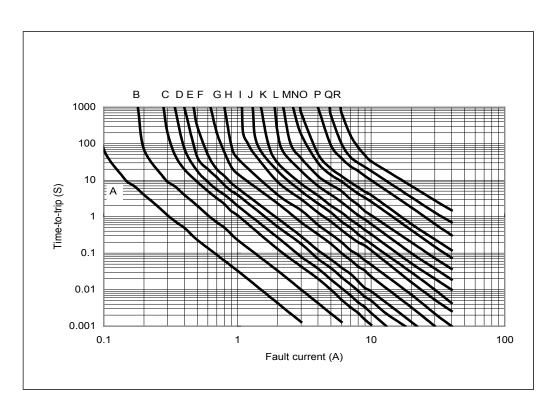




Radial Leaded PTC Resettable Fuse: FRX Series

6. Typical Time-To-Trip at 23℃

A = FRX005-60FB = FRX 010-60 F C =FRX017-60F D = FRX020-60FE =FRX025-60F F = FRX030-60FG = FRX040-60FH = FRX050-60FI =FRX065-60F J = FRX075-60FK = FRX090-60FL =FRX110-60F M = FRX135-60FN = FRX160-60FO = FRX185-60FP = FRX250-60F Q=FRX300-60F R = FRX375-60F



7. Material Specification

Lead material: FRX005-60F~FRX090-60F Tin plated copper,24 AWG.

FRX110-60F~FRX375-60F Tin plated copper, 20 AWG.

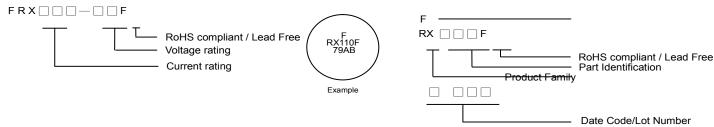
Soldering characteristics: MIL-STD-202, Method 208E.

Insulating coating:Flame retardant epoxy, meets UL-94V-O requirement

8. Part Numbering and Marking System

Part Numbering System

Part Marking System





- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Radial Leaded PTC Resettable Fuse: FRU Series

1. Summary

(a) RoHs Compliant (Lead Free) Product

(b) Applications: Wide variety of electronic equipment

(c) Product Features: Low resistance, High hold current, Solid state, Radial leaded product ideal for up to 30V

(d) Operation Current: 900mA~9.0A

(e) Maximum Voltage: 30V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: File No. E211981 C-UL: File No. E211981 TÜV: File No. R 50004084

3. Electrical Characteristics (23°℃)

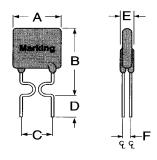
Part	Hold	Trip		Maximum	Rated	Typical		stance rance
Number	Current	Current	To Trip	Current	Voltage	Power	RMIN	R ₁ MAX
	Ін, А	Iт, А	at 5хIн	Iмах, А	V _{MAX} , Vdc	Pd, W	ohms	ohms
FRU090- 30F	0.90	1.80	5.9	40	30	0.6	0.070	0.22
FRU110- 30F	1.10	2.20	6.6	40	30	0.7	0.050	0.17
FRU135- 30F	1.35	2.70	7.3	40	30	0.8	0.040	0.13
FRU160- 30F	1.60	3.20	8.0	40	40 30		0.030	0.11
FRU185- 30F	1.85	3.70	8.7	40	30	1.0	0.030	0.09
FRU250- 30F	2.50	5.00	10.3	40	30	1.2	0.020	0.07
FRU300- 30F	3.00	6.00	10.8	40	30	2.0	0.020	0.08
FRU400- 30F	4.00	8.00	12.7	40	30	2.5	0.010	0.05
FRU500- 30F	5.00	10.00	14.5	40	30	3.0	0.010	0.05
FRU600- 30F	6.00	12.00	16.0	40	30	3.5	0.005	0.04
FRU700- 30F	7.00	14.00	17.5	40	30	3.8	0.005	0.03
FRU800- 30F	8.00	16.00	18.8	40	30	4.0	0.005	0.02
FRU900- 30F	9.00	18.00	20.0	40	30	4.2	0.005	0.02

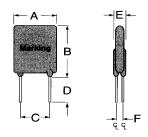
I_H=Hold current-maximum current at which the device will not trip at 23°C still air.
I_T=Trip current-minimum current at which the device will always trip at 23°C still air.
V_{MAX}=Maximum voltage device can withstand without damage at its rated current.
I_{MAX}= Maximum fault current device can withstand without damage at rated voltage (V_{MAX}).
Pd=Typical power dissipated from device when in tripped state in 23°C still air environment.
R_{MIN}=Minimum device resistance at 23°C, 1 hour after tripping.
Physical specifications:
Lead material: FRI 1090-30F~FRI 1250-30F. Tip plated copper 24 AWC

Physical specifications:
Lead material: FRU090-30F~FRU250-30F Tin plated copper, 24 AWG.
FRU300-30F~FRU900-30F Tin plated copper, 20 AWG.
Soldering characteristics:MIL-STD-202, Method 208E.
Insulating coating:Flame retardant epoxy, meets UL-94V-0 requirement.



3. Production Dimensions (millimeter)



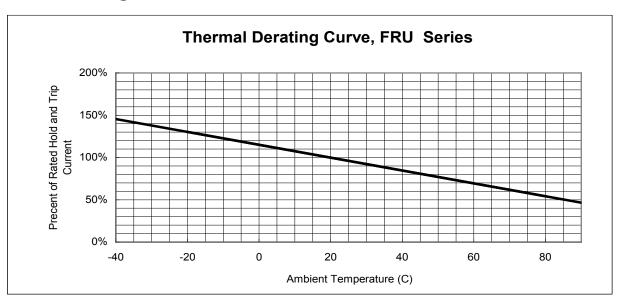


FRU 090-30F ~ FRU 250-30F Lead Size: 24AWG Φ 0.51 mm Diameter

FRU 300-30F ~ FRU 900-30F Lead Size: 20AWG

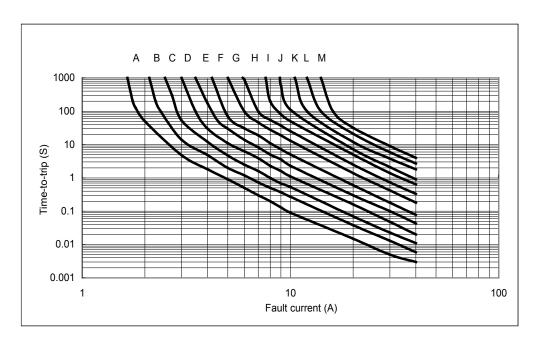
ad Si	ze: 24AWG	Lead	Size: 20AWG
0.51	mm Diameter	Ф 0.8	81 mm Diamet
	_	_	_

	Ψ 0.51 mm Diameter Ψ 0.61 mm Diameter								
Part	Α	В	С	D	E	F			
Number	Maximum	Maximum	Typical	Minimum	Maximum	Typical			
FRU090-30F	7.4	12.2	5.1	7.6	3.0	0.9			
FRU110-30F	7.4	14.2	5.1	7.6	3.0	0.9			
FRU135-30F	8.9	13.5	5.1	7.6	3.0	0.9			
FRU160-30F	8.9	15.2	5.1	7.6	3.0	0.9			
FRU185-30F	10.2	15.7	5.1	7.6	3.0	0.9			
FRU250-30F	11.4	18.3	5.1	7.6	3.0	0.9			
FRU300-30F	11.4	17.3	5.1	7.6	3.0	1.2			
FRU400-30F	14.0	20.1	5.1	7.6	3.0	1.2			
FRU500-30F	14.0	24.9	10.2	7.6	3.0	1.2			
FRU600-30F	16.5	24.9	10.2	7.6	3.0	1.2			
FRU700-30F	19.1	26.7	10.2	7.6	3.0	1.2			
FRU800-30F	21.6	29.2	10.2	7.6	3.0	1.2			
FRU900-30F	24.1	29.7	10.2	7.6	3.0	1.2			





A =FRU090-30F B =FRU110-30F C =FRU135-30F D =FRU160-30F E =FRU250-30F G =FRU300-30F H =FRU400-30F I = FRU500-30F J = FRU600-30F K =FRU700-30F L =FRU800-30F



7. Material Specification

Lead material: FRU090-30F~FRU250-30F Tin plated copper, 24 AWG.

FRU300-30F~FRU900-30F Tin plated copper, 20 AWG.

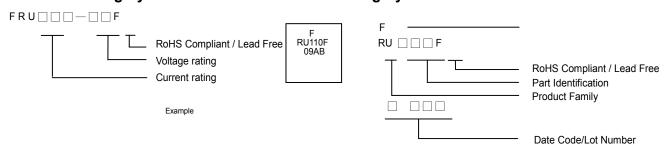
Soldering characteristics: MIL-STD-202, Method 208E.

Insulating coating:Flame retardant epoxy, meets UL-94V-0 requirement.

8. Part Numbering and Marking System

Part Numbering System

Part Marking System





- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Surface Mountable PTC Resettable Fuse: FSMD2920 Series

1. Summary

(a) RoHS Compliant (Lead Free) Product

(b) Applications : All high-density boards

(c) Product Features: 2920 Dimension, Surface mountable, Solid state, Faster time to trip than standard SMD devices.

(d) Operation Current: 300mA~3.0A

(e) Maximum Voltage: 6V~60V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: File No. E211981 C-UL: File No. E211981 TUV: File No. R50090556

Note: FSMD300-2920 TUV Pending

3. Electrical Characteristics (23°C)

Dout	Hold	Trip	Rated	Max	Typical	Max Tim	e to Trip	Resistance Tolerance		
Part Number	Current	Current	Voltage	Current	Power	Current	Time	R _{MIN}	R1 _{MAX}	
	I _H , A	I _T , A	V _{MAX} ,Vdc	I _{MAX} , A	Pd, W	Α	Sec	Ω	Ω	
FSMD030-2920	0.30	0.60	60	10	1.5	1.5	3.0	1.000	4.800	
FSMD050-2920	0.50	1.00	60	10	1.5	2.5	4.0	0.300	1.400	
FSMD075-2920	0.75	1.50	33	40	1.5	8.0	0.3	0.180	1.000	
FSMD100-2920	1.10	2.20	33	40	1.5	8.0	0.5	0.090	0.410	
FSMD125-2920	1.25	2.50	33	40	1.5	8.0	2.0	0.050	0.250	
FSMD150-2920	1.50	3.00	33	40	1.5	8.0	2.0	0.050	0.230	
FSMD185-2920	1.85	3.70	33	40	1.5	8.0	2.5	0.040	0.150	
FSMD200-2920	2.00	4.00	16	40	1.5	8.0	4.5	0.035	0.120	
FSMD250-2920	2.50	5.00	16	40	1.5	8.0	16.0	0.025	0.085	
FSMD260-2920	2.60	5.20	6	40	1.5	8.0	20.0	0.020	0.075	
FSMD300-2920	3.00	5.20	6	40	1.5	8.0	25.0	0.010	0.048	

I_H=Hold current-maximum current at which the device will not trip at 23°C still air.

I_T=Trip current-minimum current at which the device will always trip at 23°C still air.

V MAX=Maximum voltage device can withstand without damage at it rated current.(I MAX)
I MAX= Maximum fault current device can withstand without damage at rated voltage (V MAX).

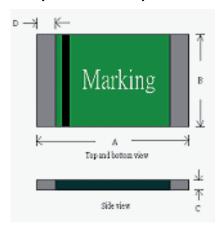
Pd=Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23°C still air environment. R_{MIN}=Minimum device resistance at 23°C prior to tripping. R_{1Max}=Maximum device resistance at 23°C measured 1 hour post trip.

Termination pad characteristics

Termination pad materials: Pure Tin

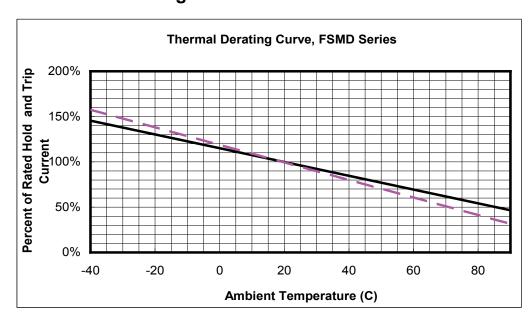


3. FSMD Product Dimensions (Millimeters)



Part		Α		3	C	3	D
Number	Min	Max	Min	Max	Min	Max	Min
FSMD030-2920	6.73	7.98	4.80	5.44	0.60	1.15	0.35
FSMD050-2920	6.73	7.98	4.80	5.44	0.60	1.15	0.35
FSMD075-2920	6.73	7.98	4.80	5.44	0.35	1.15	0.35
FSMD100-2920	6.73	7.98	4.80	5.44	0.40	1.00	0.35
FSMD125-2920	6.73	7.98	4.80	5.44	0.40	0.90	0.35
FSMD150-2920	6.73	7.98	4.80	5.44	0.40	0.90	0.35
FSMD185-2920	6.73	7.98	4.80	5.44	0.30	0.90	0.35
FSMD200-2920	6.73	7.98	4.80	5.44	0.30	0.90	0.35
FSMD250-2920	6.73	7.98	4.80	5.44	0.30	0.90	0.35
FSMD260-2920	6.73	7.98	4.80	5.44	0.30	0.90	0.35
FSMD300-2920	6.73	7.98	4.80	5.44	0.40	0.90	0.35

4. Thermal Derating Curve



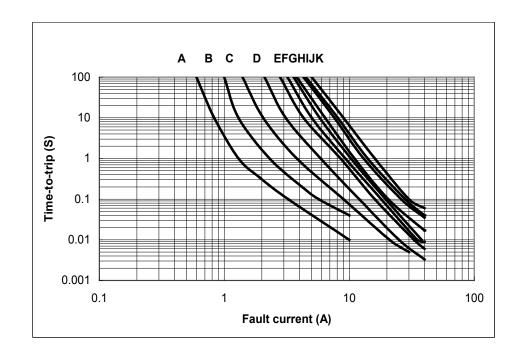
A= FSMD125-2920 ~ FSMD300-2920

B= FSMD030-2920 ~ FSMD100-2920

A B



A =FSMD030-2920 B =FSMD050-2920 C =FSMD075-2920 D =FSMD100-2920 E =FSMD125-2920 F =FSMD150-2920 G =FSMD185-2920 H =FSMD200-2920 I = FSMD250-2920 J = FSMD260-2920 K= FSMD300-2920



7. Material Specification

Terminal pad material: Pure Tin

Soldering characteristics: Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

8. Part Numbering and Marking System

Part Numbering System FSMD - - 2920 Current rating Example F200L F - - L Part Identification

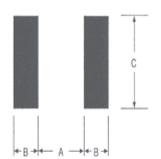


- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- -Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



9. Pad Layouts . Solder Reflow and Rework Recommendations

The dimension in the table below provide the recommended pad layout for each FSMD2920 device

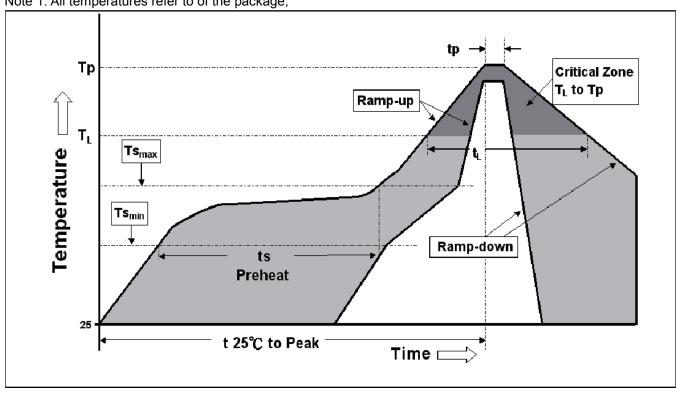


Pad dimensions (millimeters)								
Device	A Nominal	B Nominal	C Nominal					
All 2920 Series	5.1	2.3	5.6					

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Tsmax to Tp)	3 °C/second max.
Preheat :	
Temperature Min (Tsmin)	150 °C
Temperature Max (Tsmax)	200 ℃
Time (tsmin to tsmax)	60-180 seconds
Time maintained above:	
Temperature(T _L)	217 ℃
Time (t _L)	60-150 seconds
Peak/Classification Temperature(Tp)	260 ℃
:	
Time within 5℃ of actual Peak :	
Temperature (tp)	20-40 seconds
Ramp-Down Rate :	6 °C/second max.
Time 25 ℃ to Peak Temperature :	8 minutes max.

Due to "Lead Free" nature, Temperature and Dwelling time for the soldering zone is higher than those for Regular. This may cause damage to other components.

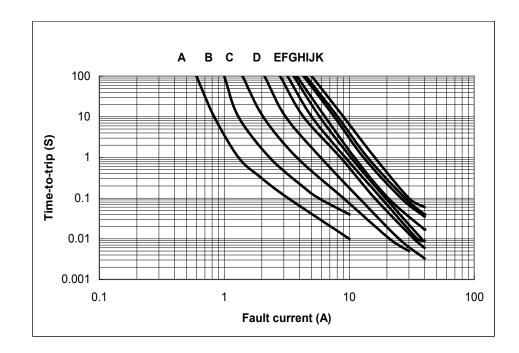
- 1. Recommended max past thickness > 0.25mm.
- 2. Devices can be cleaned using standard methods and aqueous solvent.
- 3. Rework use standard industry practices.
- 4. Storage Envorinment: < 30 / 60%RH



Note 1: All temperatures refer to of the package,



A =FSMD030-2920 B =FSMD050-2920 C =FSMD075-2920 D =FSMD100-2920 E =FSMD125-2920 F =FSMD150-2920 G =FSMD185-2920 H =FSMD200-2920 I = FSMD250-2920 J = FSMD260-2920 K= FSMD300-2920



7. Material Specification

Terminal pad material: Pure Tin

Soldering characteristics: Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

8. Part Numbering and Marking System

Part Numbering System FSMD - - 2920 Current rating Example F200L F - - L Part Identification



- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- -Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Surface Mountable PTC Resettable Fuse: FSMD1210 Series

1. Summary

(a) RoHS Compliant (Lead Free) Product

(b) Applications: All high-density boards

(c) Product Features: Small surface mountable, Solid state, Faster time to trip than standard SMD devices, Lower resistance than standard SMD devices

(d) Operation Current: 0.05A~1.5A (e) Maximum Voltage: 6V~60V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: File No. E211981 C-UL: File No. E211981 TUV: File No. R50090556

Note: FSMD110-1210R & FSMD150-1210R UL & C-UL and TUV Pending

3. Electrical Characteristics (23°C)

Part	Hold Trip		Rated	Max	Typical	Max Tim	e to Trip	Resistance Tolerance	
Number	Current	Current	Voltage	Current	Power	Current	Time	R _{MIN}	R1 _{MAX}
	I _H , A	I _T , A	V _{MAX} , Vdc	I _{MAX} , A	Pd, W	Amp	Sec	Ω	Ω
3MD005-1210	0.05	0.15	60	10	0.60	0.25	1.50	3.600	50.000
3MD010-1210	0.10	0.25	60	10	0.60	0.50	1.50	1.600	15.000
3MD020-1210	0.20	0.40	30	10	0.60	8.00	0.02	0.800	5.000
3MD035-1210	0.35	0.70	16	40	0.60	8.00	0.20	0.320	1.300
3MD050-1210	0.50	1.00	16	40	0.60	8.00	0.10	0.250	0.900
3MD075-1210	0.75	1.50	8	40	0.60	8.00	0.10	0.130	0.400
3MD110-1210R	1.10	2.20	6	100	0.80	8.00	0.30	0.060	0.210
MD150-1210R	1.50	3.00	6	100	0.80	8.00	0.50	0.040	0.110

I_H=Hold current-maximum current at which the device will not trip at 23 ℃ still air.

I_T=Trip current-minimum current at which the device will always trip at 23°C still air.

V MAX=Maximum voltage device can withstand without damage at it rated current.(I MAX)

I MAX = Maximum fault current device can withstand without damage at rated voltage (V MAX).

Pd=Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23°C still air environment.

R_{MIN}=Minimum device resistance at 23°C prior to tripping.

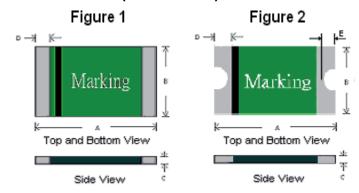
R_{1MAX}=Maximum device resistance at 23°C measured 1 hour post trip.

Termination pad characteristics

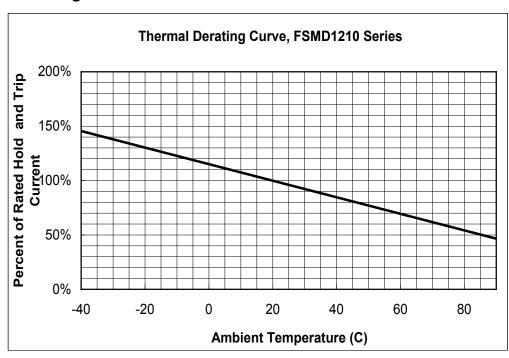
Termination pad materials: Pure Tin



3. FSMD Product Dimensions (Millimeters)

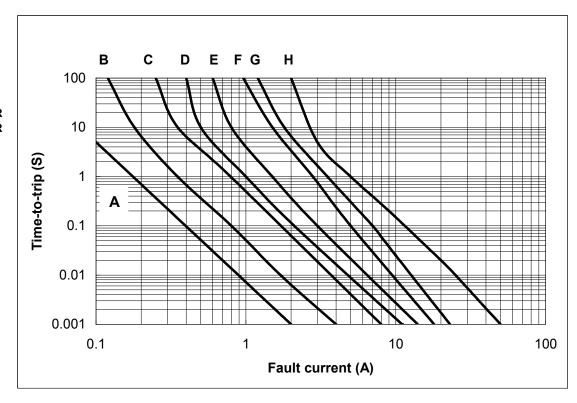


Part	Eiguro	-	4	E	3	(3	[)	E	.
Number	Figure	Min	Max	Min	Max	Min	Min	Min	Max	Min	Max
SMD005-1210	1	3.00	3.43	2.35	2.80	0.60	1.15	0.25	0.75		
SMD010-1210	1	3.00	3.43	2.35	2.80	0.60	1.15	0.25	0.75		
SMD020-1210	1	3.00	3.43	2.35	2.80	0.40	0.85	0.25	0.75		
SMD035-1210	1	3.00	3.43	2.35	2.80	0.40	0.80	0.25	0.75		
SMD050-1210	1	3.00	3.43	2.35	2.80	0.30	0.75	0.25	0.75		
SMD075-1210	1	3.00	3.43	2.35	2.80	0.30	0.70	0.25	0.75		
SMD110-1210R	2	3.00	3.43	2.35	2.80	0.60	1.00	0.25	0.75	0.10	0.45
SMD150-1210R	2	3.00	3.43	2.35	2.80	0.50	0.90	0.25	0.75	0.10	0.45





A =FSMD005-1210 B =FSMD010-1210 C =FSMD020-1210 D =FSMD035-1210 E =FSMD050-1210 F =FSMD075-1210 G =FSMD110-1210R H =FSMD150-1210R



7. Material Specification

Terminal pad material: Pure Tin

Soldering characteristics: Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

8. Part Numbering and Marking System

Part Marking System Part Numbering System F05 =FSMD005-1210 F10 =FSMD010-1210 F S M D 🗌 🗎 - 1210 R F75 F 🗌 🗌 F20 =FSMD020-1210 Part Identification F35 =FSMD035-1210 Current rating F50 =FSMD050-1210 Example F75 =FSMD075-1210 F11 =FSMD110-1210R F15 = FSMD150-1210R



- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- -Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Surface Mountable PTC Resettable Fuse: FSMD1206 Series

1. Summary

(a) RoHS Compliant (Lead Free) Product

(b) Applications: All high-density boards

(c) Product Features: Small surface mountable, Solid state, Faster time to trip than standard SMD devices, Lower resistance than standard SMD devices

(d) Operation Current: 0.05A~2.0A (e) Maximum Voltage: 6V~60V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: File No. E211981 C-UL: File No. E211981 TUV: File No. R50090556

Note:(1) FSMD075-1206 TUV Pending

(2) FSMD100-1206R, FSMD110-1206R, FSMD150-1206R & FSMD200-1206R UL, C-UL and TUV Pending

3. Electrical Characteristics (23°C)

Part Number	Hold Current	Trip Current	Rated Voltage	Max Current	Typical	Max Tim	e to Trip	Resistance Tolerance	
					Power	Current	Time	R _{MIN}	R1 _{MAX}
	I _H , A	I _T , A	V _{MAX} , Vdc	I _{MAX} , A	Pd, W	Amp	Sec	Ω	Ω
SMD005-1206	0.05	0.15	60	10	0.4	0.25	1.50	3.600	50.0
SMD010-1206	0.10	0.25	60	10	0.4	0.50	1.00	1.600	15.0
SMD020-1206	0.20	0.40	30	10	0.4	8.00	0.05	0.600	2.500
SMD035-1206	0.35	0.75	16	40	0.4	8.00	0.10	0.300	1.200
SMD050-1206	0.50	1.00	8	40	0.4	8.00	0.10	0.150	0.700
SMD075-1206R	0.75	1.50	6	100	0.6	8.00	0.20	0.090	0.290
SMD100-1206R	1.00	1.80	6	100	0.6	8.00	0.30	0.055	0.210
SMD110-1206R	1.10	2.20	6	100	0.8	8.00	0.30	0.040	0.180
SMD150-1206R	1.50	3.00	6	100	0.8	8.00	1.00	0.040	0.120
SMD200-1206R	2.00	3.50	6	100	0.8	8.00	1.50	0.018	0.080

 I_H =Hold current-maximum current at which the device will not trip at 23 $^{\circ}$ C still air. I_T =Trip current-minimum current at which the device will always trip at 23 $^{\circ}$ C still air.

V MAX=Maximum voltage device can withstand without damage at it rated current. (I MAX)

I Max = Maximum fault current device can withstand without damage at rated voltage (V MAX).

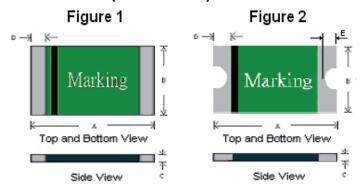
Pd=Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23°C still air environment.

R_{MIN}=Minimum device resistance at 23°C prior to tripping. R_{1Max}=Maximum device resistance at 23°C measured 1 hour post trip.

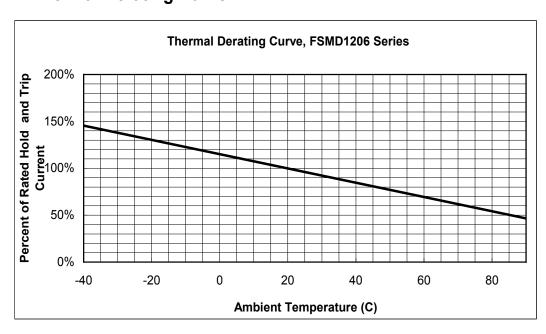
Termination pad characteristics Termination pad materials: Pure Tin



3. FSMD Product Dimensions (Millimeters)

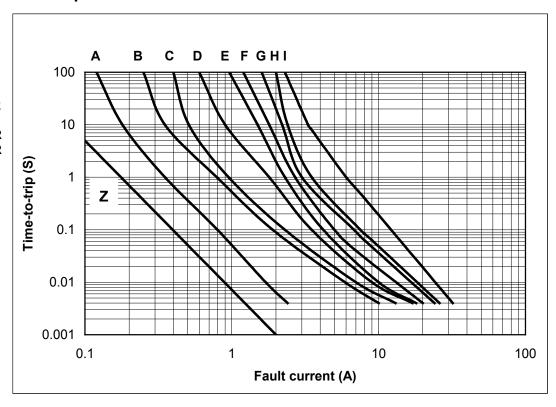


Part Number	Eigura	Α		В		С		D		E	
	Figure	Min	Max								
MD005-1206	1	3.00	3.50	1.50	1.80	0.45	0.85	0.10	0.75		
MD010-1206	1	3.00	3.50	1.50	1.80	0.45	0.85	0.10	0.75		
MD020-1206	1	3.00	3.50	1.50	1.80	0.45	0.75	0.10	0.75		
MD035-1206	1	3.00	3.50	1.50	1.80	0.45	0.75	0.10	0.75		
MD050-1206	1	3.00	3.50	1.50	1.80	0.25	0.55	0.10	0.75		
MD075-1206R	2	3.00	3.50	1.50	1.80	0.45	1.25	0.25	0.75	0.10	0.45
MD100-1206R	2	3.00	3.50	1.50	1.80	0.45	1.00	0.25	0.75	0.10	0.45
MD110-1206R	2	3.00	3.50	1.50	1.80	0.45	1.00	0.25	0.75	0.10	0.45
MD150-1206R	2	3.00	3.50	1.50	1.80	0.80	1.40	0.25	0.75	0.10	0.45
MD200-1206R	2	3.00	3.50	1.50	1.80	0.85	1.60	0.25	0.75	0.10	0.45





Z =FSMD005-1206 A =FSMD010-1206 B =FSMD020-1206 C =FSMD035-1206 D =FSMD050-1206 E =FSMD075-1206R F =FSMD100-1206R G =FSMD110-1206R H =FSMD150-1206R I = FSMD200-1206R



7. Material Specification

Terminal pad material: Pure Tin

Soldering characteristics: Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

8. Part Numbering and Marking System

Part Numbering System Part Marking System FZ =FSMD005-1206 FA = FSMD010-1206 F S M D 🗌 🗎 – 1206 R FB =FSMD020-1206 FA Part Identification FC =FSMD035-1206 Current rating FD =FSMD050-1206 Example FE =FSMD075-1206R FF =FSMD100-1206R FG =FSMD110-1206R FH =FSMD150-1206R FI = FSMD200-1206R



- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- -Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Surface Mountable PTC Resettable Fuse: FSMD0805 Series

1. Summary

(a) RoHS Compliant (Lead Free) Product

(b) Applications: All high-density boards

(c) Product Features: Small surface mountable, Solid state, Faster time to trip than standard SMD devices, Lower resistance than standard SMD devices

(d) Operation Current: 0.1A~1.0A (e) Maximum Voltage: 6V~15V

(f) Temperature Range : -40°C to 85°C

2. Agency Recognition

UL: Pending C-UL: Pending **TUV: Pending**

3. Electrical Characteristics (23°℃)

Part Number	Hold	Trip Current	Rated Voltage	Max Current	Typical	Max Tim	e to Trip	Resistance Tolerance	
	Current				Power	Current	Time	R _{MIN}	R1 _{MAX}
	I _H , A	I _T , A	V _{MAX} , Vdc	I _{MAX} , A	Pd, W	Amp	Sec	Ω	Ω
FSMD010-0805	0.10	0.30	15	100	0.5	0.50	1.50	0.700	6.000
FSMD020-0805	0.20	0.50	9	100	0.5	8.00	0.02	0.400	3.500
FSMD035-0805	0.35	0.75	6	100	0.5	8.00	0.10	0.250	1.200
FSMD050-0805R	0.50	1.00	6	100	0.5	8.00	0.10	0.150	0.850
FSMD075-0805R	0.75	1.50	6	40	0.6	8.00	0.20	0.090	0.350
FSMD100-0805R	1.00	1.95	6	40	0.6	8.00	0.30	0.060	0.210

I_H=Hold current-maximum current at which the device will not trip at 23°C still air.

I_T=Trip current-minimum current at which the device will always trip at 23°C still air.

V_{MAX}=Maximum voltage device can withstand without damage at it rated current.(I MAX) I_{MAX}= Maximum fault current device can withstand without damage at rated voltage (V MAX).

Pd=Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23°C still air environment.

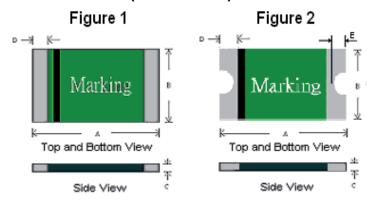
R_{MIN}=Minimum device resistance at 23°C prior to tripping. R_{1Max}=Maximum device resistance at 23°C measured 1 hour after tripping or reflow soldering of 260°C for 20 seconds.

Termination pad characteristics

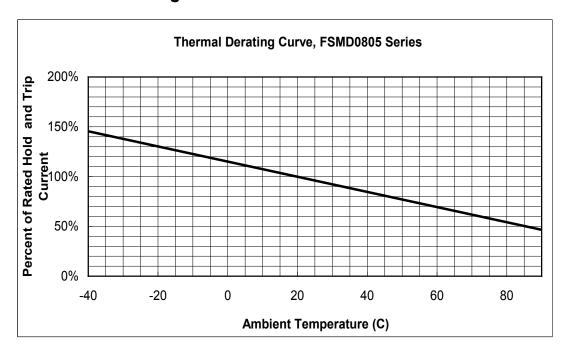
Termination pad materials: Pure Tin



3. FSMD Product Dimensions (Millimeters)



Part	Figure	A A		В		С		D		Е	
Number		Min	Max								
FSMD010-0805	1	2.00	2.30	1.20	1.50	0.55	1.00	0.20	0.60		
FSMD020-0805	1	2.00	2.30	1.20	1.50	0.55	1.00	0.20	0.60		
FSMD035-0805	1	2.00	2.30	1.20	1.50	0.45	0.75	0.20	0.60		
FSMD050-0805R	2	2.00	2.20	1.20	1.50	0.55	1.25	0.20	0.60	0.10	0.45
FSMD075-0805R	2	2.00	2.20	1.20	1.50	0.55	1.25	0.20	0.60	0.10	0.45
FSMD100-0805R	2	2.00	2.20	1.20	1.50	0.75	1.80	0.20	0.60	0.10	0.45





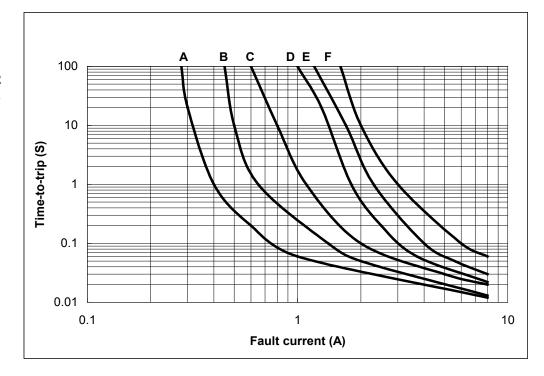
A =FSMD010-0805

B =FSMD020-0805

C =FSMD035-0805

D =FSMD050-0805R E =FSMD075-0805R

F =FSMD100-0805R



7. Material Specification

Terminal pad material: Pure Tin

Soldering characteristics: Meets EIA specification RS 186-9E, ANSI/J-std-002 Category 3

8. Part Numbering and Marking System

Part Numbering System Part Marking System FSMD□□□-0805 R F1 =FSMD010-0805 F2 =FSMD020-0805 F3 =FSMD035-0805 F3 =FSMD035-0805 F5 =FSMD050-0805R F7 =FSMD075-0805R F7 =FSMD075-0805R F7 =FSMD075-0805R F0 =FSMD100-0805R



- -PPTC device are intended for occasional overcurrent protection. Application for repeated overcurrent condition and/or prolonged trip are not anticipated.
- -Avoid contact of PPTC device with chemical solvent. Prolonged contact will damage the device performance.



Änderungen der technischen Daten und Liefermöglichkeiten bleiben ohne Ankündigung vorbehalten.

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